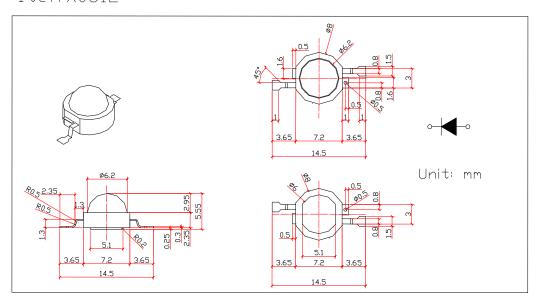
# 2W HIGH POWER LED (EMITTER-6) WW051E

Features	Applications
* Long operating life	* Reading lights (car, bus, aircraft)
* Highest flux	* LCD Backlights/light Guides
* Available in White:2500K-25000K	* Fiber optic alternative/ Decorative Entertainment
* Lambertian radiation pattern	* Mini-accent/Up lighters/Down lighters/ Orientation
* More energy efficient than incandescent and most	* Indoor/Outdoor commercial and Residential
halogen lamps	Architectural
* Low voltage DC operated	* Cove/Under shelf/Task
* Cool beam, safe to the touch	* Bollards/Security/Garden
* Instant light (less than 100ns )	* Portable (flashlight, bicycle)
* Fully dimmable	* Edge-lit signs (Exit, point of sale)
* No UV	* Automotive Exit (Stop-Tail-Turn,CHMSL, Mirror
	Side Repeat)
* Superior ESD protection	* Traffic signaling / Beacons / RailCrossing and
	Wayside
* Eutectic die bonding	
* RoHS compliant	

#### **PACKAGE**

### Item:X051E





#### 20110201

Typical Optical/ Electrical Characteristics @TJ=25℃

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=550mA	2.80		4.0	V
Reverse Current	lr	VR=5v			50	uA
50% Power Angle	201/2	IF=550mA	40		80	deg
Luminous Intensity	φV	IF=550mA		130		lm
Recommend Forward Current	lf			550		mA
Chromaticity	Тс	IF=550mA	2500		4500	k
Thermal Resistance, Junction to Case	RJP	IF=550mA		10		°C/w

#### Notes:

- 1. Tolerance of measurement of forward voltage±0.1V.
- 2. Tolerance of measurement of peak Wavelength±2.0nm.
- 3. Tolerance of measurement of luminous intensity±15%.

**Absolute Maximum Rating** 

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	lF	550	mA
Peak Forward Current*	<b>I</b> FP	700	mA
Reverse Voltage	VR	5	V
Power Dissipation	Po	1000	mW
Electrostatic discharge	Esp	±4500	V
Operation Temperature	Topr	-40~+80	$^{\circ}$ C
Storage Temperature	Тѕтс	-40~+100	$^{\circ}\!\mathbb{C}$
Lead Soldering Temperature*	TsoL	Max. 260°C for 3sec Max.	

<sup>\*</sup>IFP Conditions : Pulse Width≤10msec duty≤1/10

- \* All high power emitter LED products mounted on aluminum metal-core printed circuit board, can be lighted directly, but we do not recommend lighting the high power products for more than 5 seconds without a appropriate heat dissipation equipment.
- \* Re-flow, wave peak and soak- stannum soldering etc.is not suitable for this products.
- \* Suggest to solder it by professional high power LED soldering machine.
- \* Can use invariable-temperature searing-iron with soldering condition:≤260 degree less than 3 seconds.



#### **Typical Optical/Electrical Characteristics Curves** (TJ=25° Unless Otherwise Noted )

Fig 1. Relative Luminous FLux vs. Forward Current

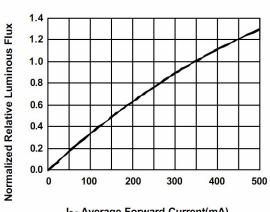
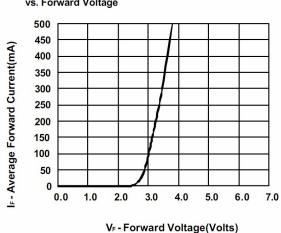


Fig 2. Forward Current vs. Forward Voltage



IF - Average Forward Current(mA)

Fig 3. Maximum Forward Current vs. Ambient Temperature.

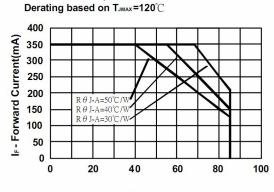
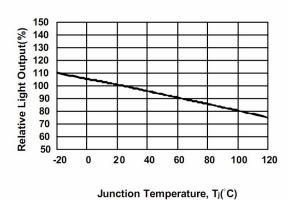


Fig 4. Relative Light Output vs. Junction Temperature



T<sub>A</sub> - Ambient Temperature (°C)

Fig 5. Relative Spectral Power Distribution vs. Wavelength

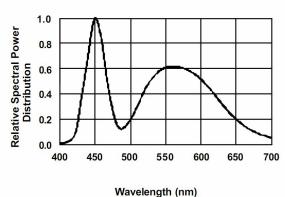
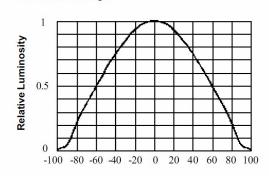
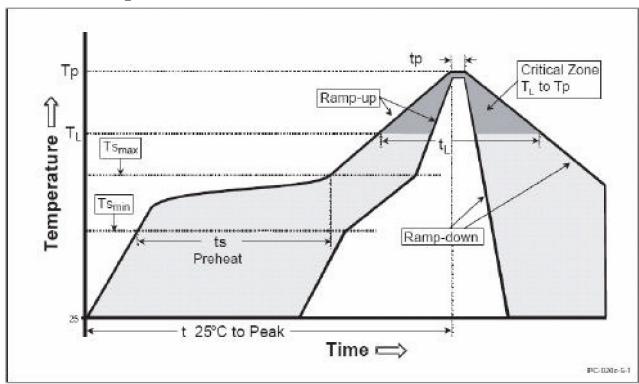


Fig 6. Relative Luminosity vs. Radiation Angle



Radiation Angle(Degrees)

### **Reflow Soldering Characteristics**



Profile Feature	Pb-Free Assembly
Preheat	
- Temperature Min (Tsmin)	60-180 seconds
- Temperature Max (Tsmax)	150 °C
- Time (tsmin to tsmax)	200 °C
- Temperature (TL)	
- Time (tL)	60-150 seconds
Time maintained above:	217 °C
Peak/Classification Temperature (Tp)	260 °C
Time within 5 °C of actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

#### **Notes**

### 1. All temperatures refer to Solder Pad